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## 528-AG12D-ES-LF Product Details



# **528-AG12D-ES-LF** (1571551-9)Active

## **DIP Sockets**

Always EU RoHS/ELV Compliant (Statement of Compliance)

### **Product Highlights:**

- DIP Socket
- Number of Positions = 28
- Row-to-Row Spacing = 15.24 mm
- Thru Hole
- Mount Style = Vertical

View all Features

## **Quick Links**

Check Pricing & Availability Search for Tooling Product Feature Selector <u>Contact Us Abou</u>t This Product

### **Documentation & Additional Information**

### **Product Drawings:**

 CLOSED FRAME DIP, ECONOMY LEAD FREE (REF AUGAT 500 S... (PDF, English)

### Catalog Pages/Data Sheets:

• None Available

### **Product Specifications:**

None Available

### **Application Specifications:**

None Available

#### **Instruction Sheets:**

None Available

### **CAD Files:**

None Available

### Additional Information:

• Product Line Information

### Related Products:

Tooling

# List all Documents

### Product Features (Please use the Product Drawing for all design activity)

## **Product Type Features:**

- <u>Product Type</u> = DIP Socket
- Number of Positions = 28
- Profile = Standard
- Frame Style = Closed
- Leg Style = Straight • Sleeve Material = Nickel
- Product Series = 500 Series

### **Electrical Characteristics:**

- Insulation Resistance (M?) = 5,000
- Contact Resistance (m?) = 10

### **Termination Related Features:**

- Termination (Solder) Post Length (mm [in]) = 3.18 [0.125]
- Solder Tail Contact Plating = Tin

### **Body Related Features:**

- Row-to-Row Spacing (mm [in]) = 15.24 [0.600]
- <u>Mount Style</u> = Vertical
- Centerline (mm [in]) = 2.54 [0.100]

## **Contact Related Features:**

- <u>Contact Mount</u> = Thru Hole
- <u>Contact Material</u> = Beryllium Copper
- Contact Mating Area Plating = Tin
- Contact Style = Stamped + Formed
- Mating Contact Type = Four-Fingered

# **Configuration Related Features:**

• Height Above PC Board (mm [in]) = 4.57 [0.180]

# **Industry Standards:**

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- <u>Lead Free Solder Processes</u> = Wave solder capable to 240°C, Wave solder capable to 260° C, Wave solder capable to 265°C
- RoHS/ELV Compliance History = Always was RoHS compliant

### Conditions for Usage:

• Temperature Range (°C) = 105

# **Packaging Related Features:**

• Packaging Method = Tube

### Other:

Brand = AMP

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